

Hyperfast Rectifier, 30 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





PRIMARY CHARACTERISTICS									
I _{F(AV)}	30 A								
V _R	600 V								
V _F at I _F at 125 °C	1.3 V								
T _J max.	175 °C								
t _{rr} (typ.)	22 ns								
Package	TO-220AC 2L								
Circuit configuration	Single								

FEATURES

 Best in class forward voltage drop and switching losses trade off



- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Meets JESD 201 class 1A whisker test
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

MECHANICAL DATA

Case: TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Repetitive peak reverse voltage	V_{RRM}		600	V						
Average rectified forward current	I _{F(AV)}	T _C = 106 °C, D = 0.50	30							
Non-repetitive peak surge current	I _{FSM}	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	310	Α						
Repetitive peak forward current	I _{FRM}	$T_C = 106 ^{\circ}\text{C}, D = 0.50, f = 20 \text{kHz}$	60							
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)										
PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS					
Breakdown voltage, blocking voltage	V_{BR} , V_{R}	I _R = 100 μA	600	-	-	.,				
Forward voltage	V _F	I _F = 30 A	-	1.6	2.1	V				
Forward voltage		I _F = 30 A, T _J = 125 °C	-	1.3	-					
Daylorea lackage aliment	I _R	$V_R = V_R$ rated	-	-	20					
Reverse leakage current		T _J = 125 °C, V _R = V _R rated	-	-	500	μA				
Junction capacitance	C _T	V _R = 200 V	-	36	-	pF				
Series inductance	L _S	Measured to lead 5 mm from package body	-	8	=.	nH				



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS				
		$I_F = 1.0 A, dI_F/dt =$	-	22	1					
Reverse recovery time	t _{rr}	T _J = 25 °C		-	39	-	ns			
		T _J = 125 °C		-	50	-				
Dook receivery ourrent		T _J = 25 °C	$I_F = 20 \text{ A}$ $dI_F/dt = 1000 \text{ A/}\mu\text{s}$ $V_R = 400 \text{ V}$	-	14	-	А			
Peak recovery current	I _{RRM}	T _J = 125 °C		-	24	-				
Devenue ve estant elegan	0	T _J = 25 °C		-	253	-	nC			
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	785	-				
Poverse recovery time	t _{rr}	T _J = 25 °C		-	41	-	ns A			
Reverse recovery time		T _J = 125 °C		-	56	-				
Dools recovery as week	1 .	T _J = 25 °C	I _F = 30 A	-	16	-				
Peak recovery current	I _{RRM}	T _J = 125 °C	dI _F /dt = 1000 A/μs V _R = 400 V	-	27	-				
Poverse receivery charge	0	T _J = 25 °C		-	306	-	200			
Reverse recovery charge	Q_{rr}	T _J = 125 °C	1	-	952	-	nC			

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Thermal resistance, junction-to-case	R _{thJC}		-	-	1.3	°C/W				
Weight			-	2.0	-	g				
Mounting torque			6 (5)	-	12 (10)	kgf · cm (lbf · in)				
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C				
Marking device		Case style: TO-220AC 2L	E5TX3006							

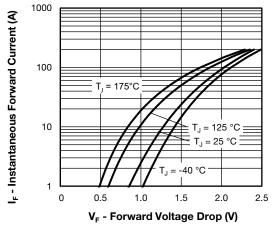


Fig. 1 - Typical Forward Voltage Drop Characteristics

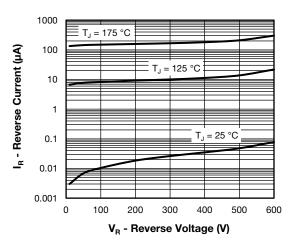


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

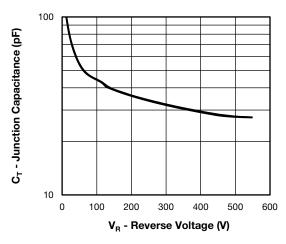


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

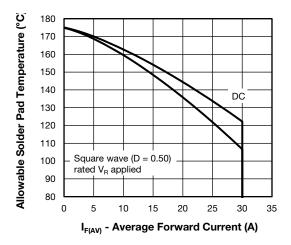


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current

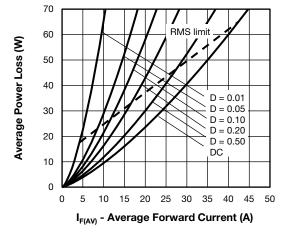


Fig. 5 - Average Power Loss vs. Average Forward Current

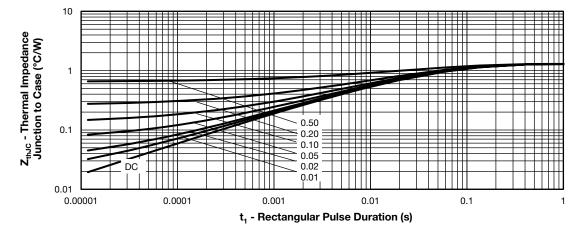


Fig. 6 - Thermal Impedance Z_{thJC} - Characteristics



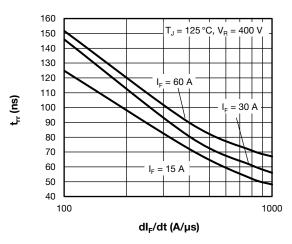


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

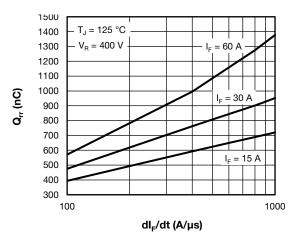


Fig. 8 - Typical Reverse Recovery Charge vs. dl_F/dt

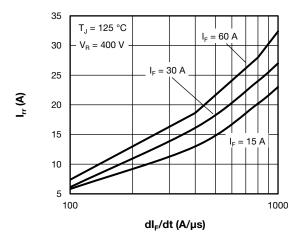


Fig. 9 - Typical Reverse Recovery Current vs. dl_F/dt

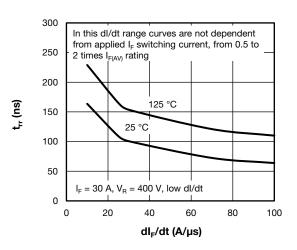


Fig. 10 - Typical Reverse Recovery Time vs. dl_F/dt

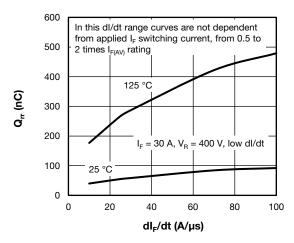


Fig. 11 - Typical Reverse Recovery Charge vs. dl_F/dt

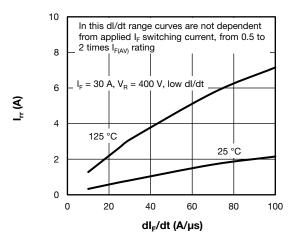


Fig. 12 - Typical Reverse Recovery Current vs. dI_F/dt

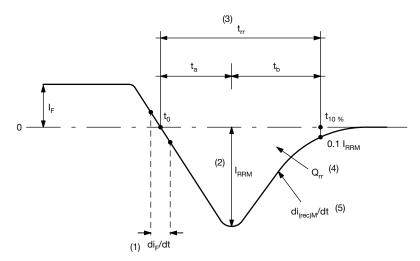


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

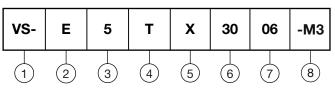
- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from t₀, crossing point of negative going I_F, to point t_{10%}, 0.1 I_{RRM}

$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

(5) di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}

ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 E = single diode
- **3** 5 = FRED generation 5
- 4 Package: T = TO-220AC 2L
- 5 X = hyperfast recovery
- 6 Current rating (30 = 30 A)
- 7 Voltage rating (06 = 600 V)
- 8 Environmental digit:
 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

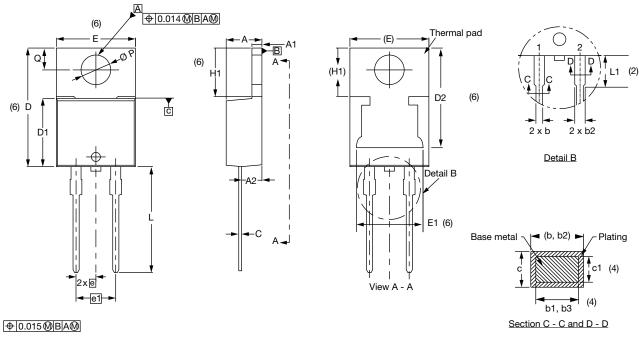
ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-E5TX3006-M3	50	Antistatic plastic tubes							

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?96156						
Part marking information	www.vishay.com/doc?95391						
SPICE model	www.vishay.com/doc?96918						



TO-220AC 2L

DIMENSIONS in millimeters and inches



Lead tip

Conforms to JEDEC® outline TO-220AC

SYMBOL	MILLIN	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355							•	

Notes

- $^{(1)}$ Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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